



PRODUCT SPECIFICATIONS

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TYPE: BUZ53A

CASE OUTLINE: TO-204AA (TO-3)

HIGH VOLTAGE POWER MOSFET N-CHANNEL

ABSOLUTE MAXIMUM RATING:

Drain – Source Voltage	V_{DSS}	1000	Vdc
Drain – Gate Voltage	V_{DGR}	1000	Vdc
Drain Current – Continuous	I_D	2.6	Adc
Drain Current – Pulsed	I_{DM}	10	Adc
Gate – Source Voltage	V_{GS}	± 20	Vdc
Power Dissipation	P_D	78	Watts
Inductive Current	I_L		Adc
Operating and Storage Temperature	T_J & T_{stg}	-55 to +150	°C
Lead Temperature From Case	T_L		°C

ELECTRICAL CHARACTERISTICS TA @ 25°C

Parameters	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_b = .25mA$	1000			Vdc
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_b = 1.0mA$	2.1		4.0	Vdc
Gate – Body Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 1000V, V_{GS} = 0V,$ $V_{DS} = 1000V, V_{GS} = 0V, T_J = 125^\circ C$			0.25 1.0	mA mA
On State Drain Current	$I_{D(on)}$					Adc
Drain Source On-Resistance	$r_{DS(on)}$	$V_{GS} = 10V, I_b = 1.5A$			5.0	Ohms
Forward Transconductance	g_{FS}	$V_{DS} = 25V, I_b = 1.5A$	0.7			mhos
Drain-Source On Voltage	$V_{DS(on)}$					Vdc
Drain-Source-On Voltage	$V_{DS(on)}$					Vdc
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1 MHz$			2100	pF
Output Capacitance	C_{oss}				120	pF
Reverse Transfer Capacitance	C_{rss}				55	pF



TYPE: **BUZ53A**

Drain Source Diode Characteristics		Symbol	Min	Typ	Max	Units
Forward On Voltage	$I_F = 5.2A, V_{GS} = 0V$	V_{SD}			1.3	Vdc
Reverse Recovery Time	$I_F = 2.6A$	t_{rr}		2000		ns
Reverse Recovery Charge	$di_F/dt = 100A/\mu s, V_{GS} = 0V, V_R = 100V$	Q_{rr}		15		nC
Total Gate Charge		Q_g				nC
Gate – Source Charge		Q_{gs}				nC
Gate – Drain Charge		Q_{gd}				nC

Switching Characteristics		Symbol	Min	Typ	Max	Units
Turn-On Time		t_{on}				
Turn-Off Time		t_{off}				
Delay Time (Turn On)	$V_{DD} = 30V, I_b = 2.0A$ $V_{GS} = 10V, R_{GS} = 50\Omega$ $R_{gen} = 50\Omega$	$t_{d(on)}$			45	ns
Rise Time		t_r			60	ns
Delay Time (Turn Off)		$t_{d(off)}$			140	ns
Fall Time		t_f			80	ns

Thermal Characteristics		Symbol			Units
Junction To Case		$R_{\theta JC}$			$^{\circ}C/W$
Junction To Ambient		$R_{\theta JA}$			$^{\circ}C/W$
Internal Package Inductance		Symbol	Typ	Max	Units
Internal Drain Inductance		L_d	5.0		nH
Internal Source Inductance		L_s	12.5		nH